



**LEAD-FREE SOLDERING PROFILE:**

PRE-HEAT: ABOVE 130°C FOR 75 SECONDS MAX.  
REFLOW: 278°C FOR 8 SECONDS MAX.  
TIME: 250 SECONDS MAX.  
MAX. TEMP: 280°C

REVISION				
REV	DATE	DESCRIPTION		
A	5/8/19	520782GCP - RELEASE MRY		
B	5/14/20	522325ECP/D - ADD FRONT VIEW MRY		